

10/570663
IAP6 Rec'd PCT/PTO 06 MAR 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Akihiko ENDO et al. **Mail Stop PCT**
Appl. No: Not Yet Assigned **PCT Branch**
I. A. Filed : September 8, 2004
(U.S. National Phase of PCT/JP2004/013069)
For : METHOD FOR PRODUCING BONDED WAFER

CLAIM OF PRIORITY

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop PCT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

Applicant hereby claims the right of priority granted pursuant to 35 U.S.C. 119 and 365 based upon Japanese Application No. 2003-315988, filed September 8, 2003. The International Bureau already should have sent a certified copy of the Japanese application to the United States designated office. If the certified copy has not arrived, please contact the undersigned.

Respectfully submitted,
Akihiko ENDO et al.


William S. Boshnick
Reg. No. 44,550


Leslie J. Paperner
Reg. #33329

March 6, 2006
GREENBLUM & BERNSTEIN, P.L.C.
1950 Roland Clarke Place
Reston, VA 20191
(703) 716-1191